

**RF Matrix Amplifier**

**Description**

The CXA2570N is an IC developed for the RF signal processing of compact disc players.

**Features**

- Wide band RF signal processing
- RF system VCA circuit
- RF system equalizer (supports CAV mode)
- Supports pickups with built-in RF summing amplifier
- Low power consumption mode (EQ Pass mode)
- RW/ROM switching mode

**Functions**

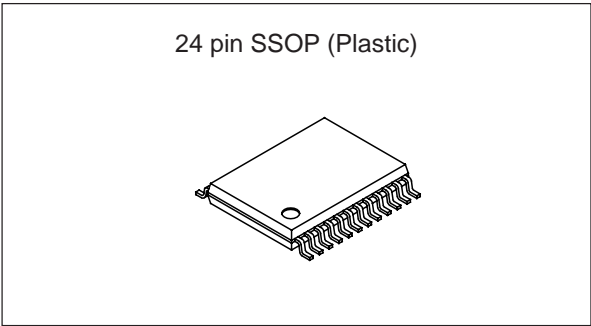
- RFAC summing amplifier, equalizer, VCA
- RFDC summing amplifier
- Focus error amplifier
- Tracking error amplifier
- Automatic power control
- VC buffer amplifier

**Applications**

CD-ROM/RW compatible systems

**Structure**

Bipolar silicon monolithic IC



**Absolute Maximum ratings**

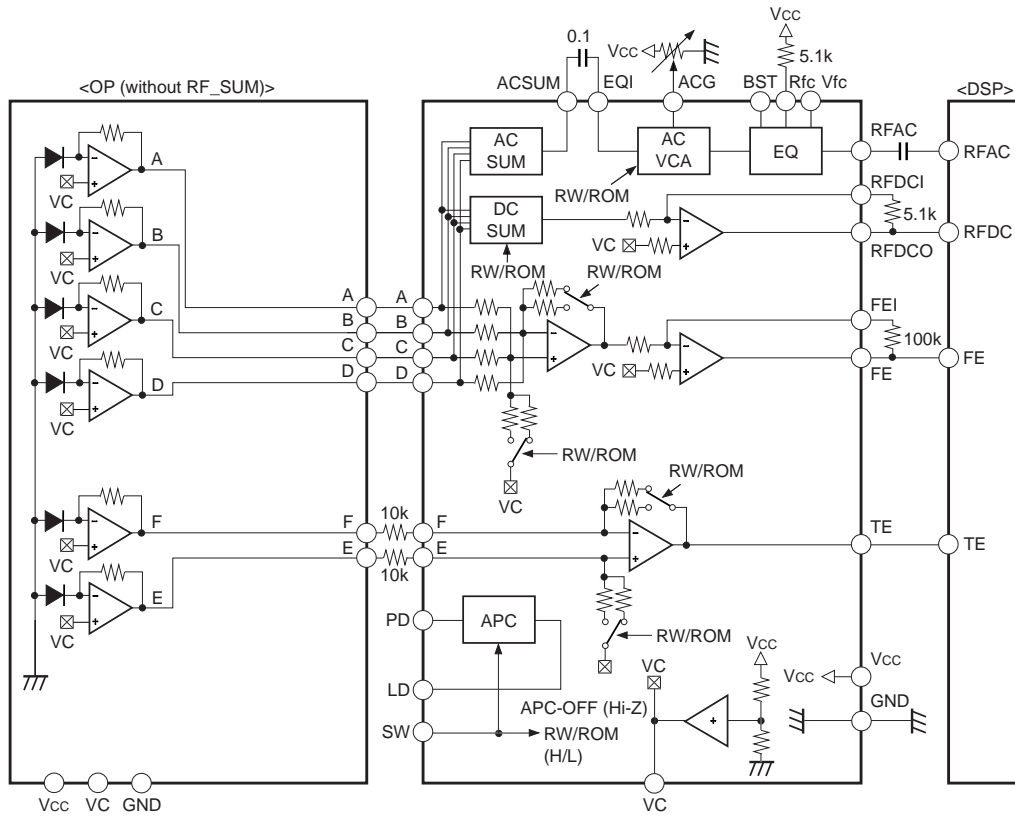
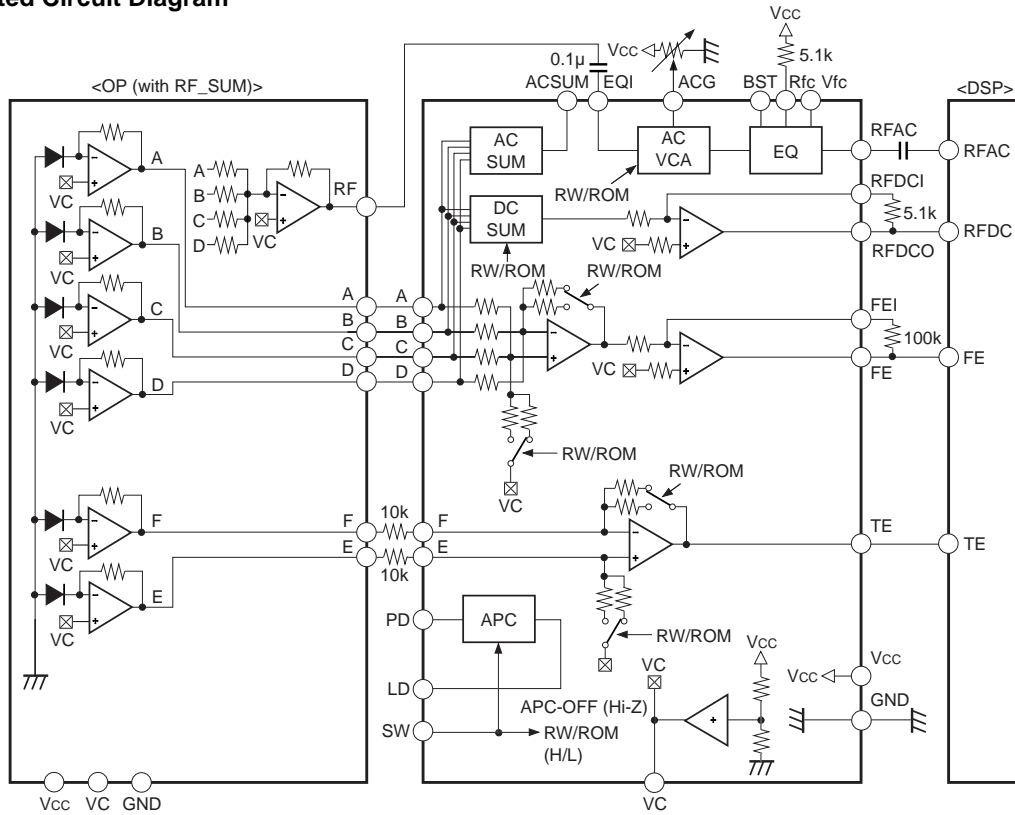
- Supply voltage  $V_{CC}$  7 V
- Operating temperature  $T_{opr}$  -20 to +75 °C
- Storage temperature  $T_{stg}$  -65 to +150 °C
- Allowable power dissipation  $P_D$  620 mW

**Operating Conditions**

- Supply voltage  $V_{CC} - GND$  3.0 to 5.5 V
- Operating temperature  $T_{opr}$  -20 to +75 °C

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Connected Circuit Diagram



## Pin Description

Pin No.	Symbol	I/O	Description
1	LD	Out	APC amplifier output.
2	PD	In	APC amplifier input.
3	EQ_IN	In	RFAC system VCA block and EQ block input.
4	AC_SUM	Out	RFAC system RF SUM output.
5	GND	In	Ground.
6	A	In	A signal input.
7	B	In	B signal input.
8	C	In	C signal input.
9	D	In	D signal input.
10	E	In	E signal input.
11	F	In	F signal input.
12	SW	In	Mode switching signal input.
13	RFAC	Out	RFAC signal output.
14	FE	Out	Focus error signal output.
15	FEI	—	FE amplifier virtual ground.
16	TE	Out	Tracking error signal output.
17	Vcc	In	Vcc.
18	RFG	In	RFAC system VCA block low-frequency gain adjustment.
19	BST	In	EQ boost amount adjustment range.
20	VFC	In	EQ cut-off frequency adjustment.
21	RFC	In	EQ cut-off frequency adjustment.
22	VC	Out	VC voltage output.
23	RFDCO	Out	RFDC signal output.
24	RFDCI	—	RFDC amplifier virtual ground.

Pin Description and Equivalent Circuit

Pin No.	Symbol	I/O	Equivalent circuit	Description
1	LD	O		APC amplifier output.
2	PD	I		APC amplifier input.
3	EQ_IN	I		Equalizer circuit input.
4	AC_SUM	O		RFAC summing amplifier output.
5	GND	—	—	Ground.

Pin No.	Symbol	I/O	Equivalent circuit	Description
6	A	I		RF summing amplifier and focus error amplifier input.
7	B	I		
8	C	I		
9	D	I		
10	E	I		Tracking error amplifier input.
11	F	I		
16	TE	O		Tracking error amplifier output.
12	SW	I		CD-ROM/RW switching input. RW when connected to Vcc, ROM when connected to GND.
13	RFAC	O		RFAC amplifier output.
14	FE	O		Focus error amplifier output. Focus error amplifier gain adjustment. The gain is adjusted by the external resistance value connected between this pin and Pin 14.
15	FEI	I		

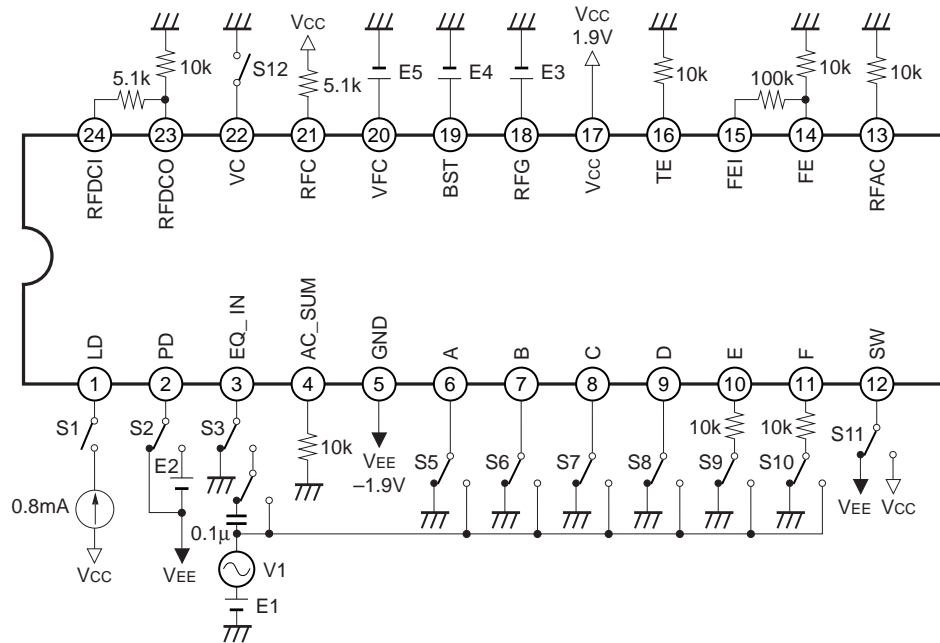
Pin No.	Symbol	I/O	Equivalent circuit	Description
17	Vcc	—	—	Power supply.
18	RFG	I		Sets the RFAC low-frequency gain.
19	BST	I		Input for adjusting the equalizer circuit boost amount.
20	VFC	I		Input for adjusting the equalizer circuit boost frequency with the control voltage.
21	RFC	I		Input for adjusting the equalizer circuit boost frequency with external resistance.
22	VC	O		(Vcc + GND)/2 voltage output.
23	RFDC	O		RFDC amplifier output. This pin serves as the eye pattern check point.
24	RFDCI	I		RFDC amplifier gain adjustment. The gain is adjusted by the external resistance value connected between this pin and Pin 23.



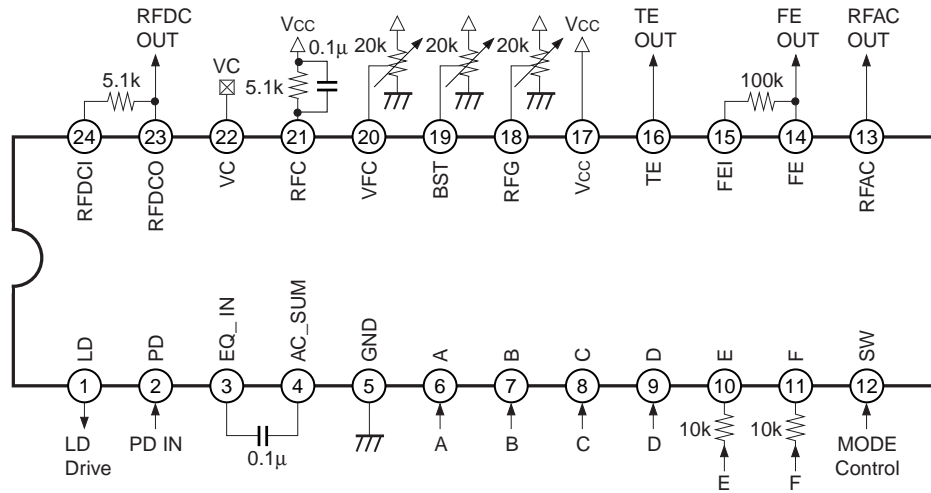
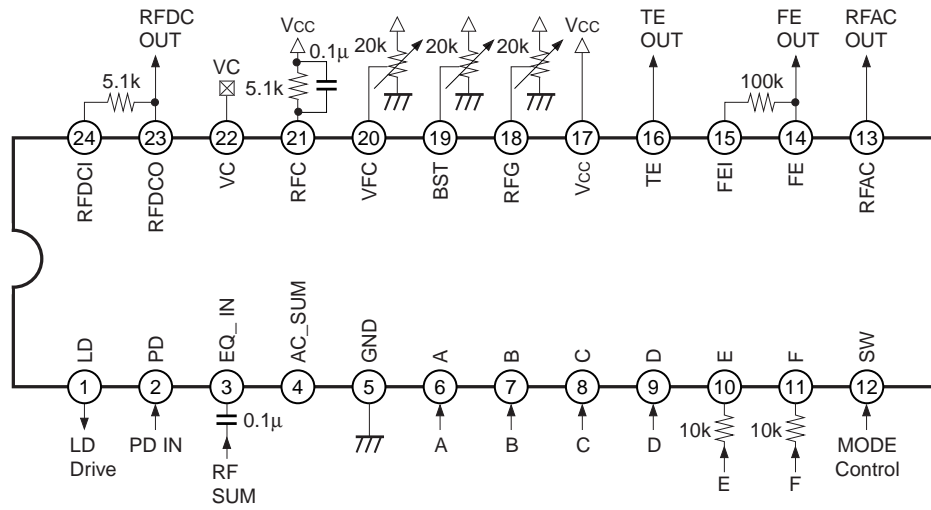




Electrical Characteristics Measurement Circuit



Application Circuits

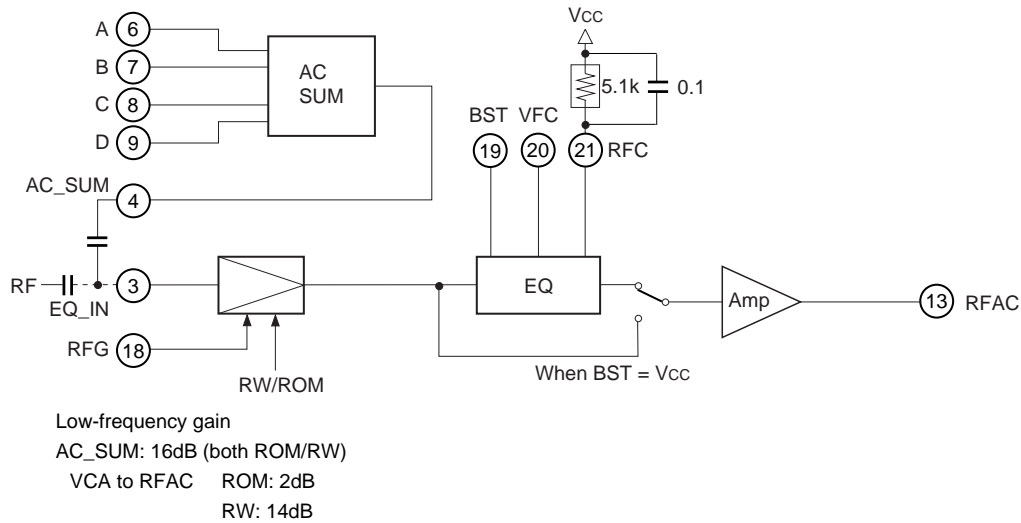


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**Description of Functions**

• **RFAC**

The RF signal input by connecting capacitance to the EQ\_IN pin is equalized, arithmetically amplified and then output from the RFAC pin.



The EQ can be bypassed by connecting the BST control pin (Pin 19) to Vcc. In this case only the EQ block enters sleep mode and the low power consumption mode (slim mode) is activated. The low-frequency gain is the same value as for EQ ON mode.

The RF\_SUM input dynamic range is  $VC \pm 300mV$  (typ.).

If RF (summing signal) is present at the pickup output pin, input the addition output signal to the EQ\_IN pin (Pin 3) coupled by capacitance.

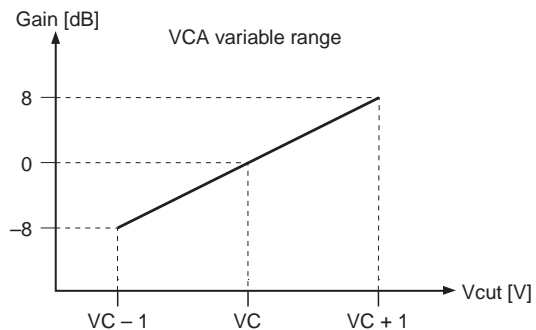
When using a pickup without a summing output function, perform addition with the AC SUM block and then input the signal to the EQ\_IN pin coupled by capacitance.

RW/ROM switching is done by the VCA block, so either input method can be used without problem.

The RW gain is 12dB higher than the ROM gain.

The VCA low-frequency gain can be adjusted by the RFG pin (Pin 18) voltage.

The control voltage vs. low-frequency gain characteristics are shown in the graph to the right.



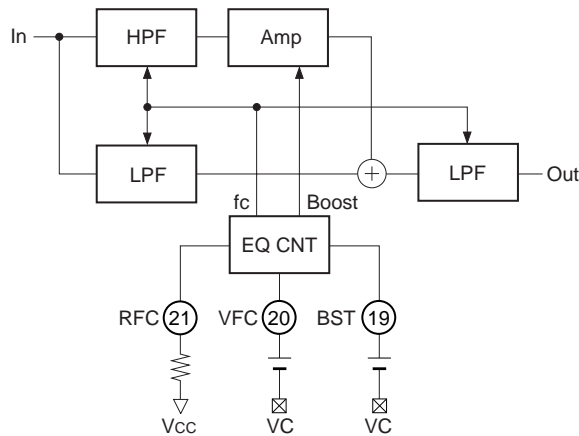
The RFAC pin (Pin 13) is an NPN transistor emitter follower output.

The maximum drive current is approximately 2mA.

If the load capacitance distorts the output waveform, increase the drive current.

Connect resistance between Pin 13 and GND.

• EQ

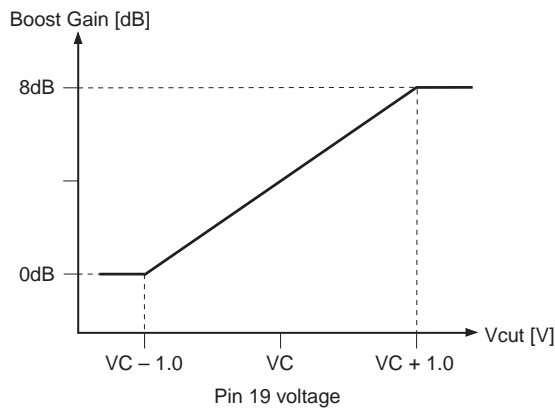


The diagram to the left shows the EQ internal block diagram. The EQ consists of a combination of HPF and LPF. The HPF and LPF transmittance is the Bessel function. The boost gain can be adjusted by adjusting the HPF gain. The boost frequency is adjusted by the RFC external resistance value and the VFC control voltage value.

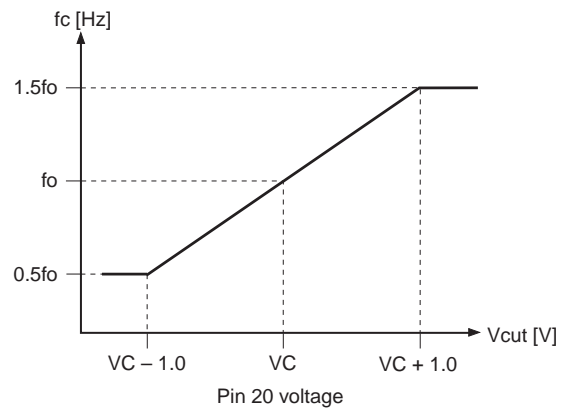
RFC resistance value: The cut-off frequency  $f_o$  of each filter is adjusted by the Pin 21 external resistance value. The VFC voltage can be varied using this  $f_o$  as the reference.

VFC voltage:  $f_o$  can be changed by the voltage applied to Pin 20.

The boost gain can be adjusted by the BST pin control voltage. The control characteristics are shown in the graph below.

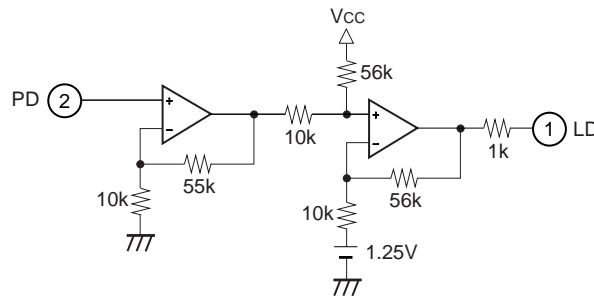


The cut-off frequency control characteristics are shown in the graph below.



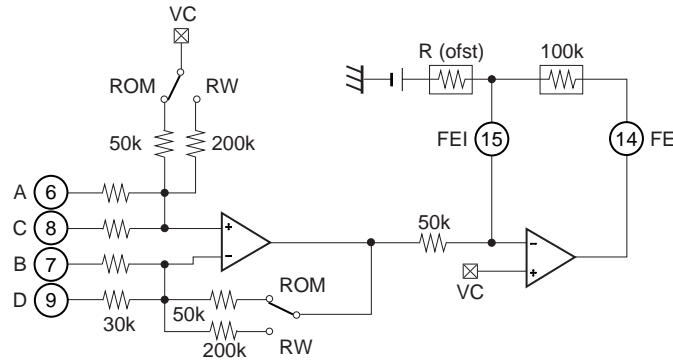
• APC (Automatic Power Control)

When the laser diode is driven by a constant current, the optical power output has extremely large negative temperature characteristics. Therefore, the current must be controlled to maintain the monitor photodiode output at a constant level. This control is performed by the APC function



• Focus Error

The signals input to the A and C pins and the B and D pins are arithmetically amplified and the focus error signal is output. This circuit has RW/ROM switching, low-frequency gain adjustment and offset adjustment (external resistance) functions.

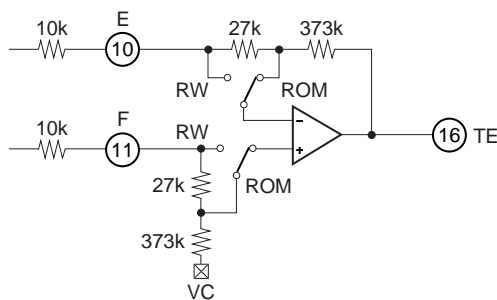


FE = Gain {(B + D) – (A + C)}

Low-frequency gain	ROM: 16dB
	RW: 28dB
Cut-off frequency $f_c$ (typ.)	ROM: 400kHz
	RW: 300kHz

• Tracking Error

The signals input to the E and F pins are arithmetically amplified and the tracking error signal is output. This circuit has RW/ROM switching, low-frequency gain adjustment and offset adjustment (external resistance) functions.

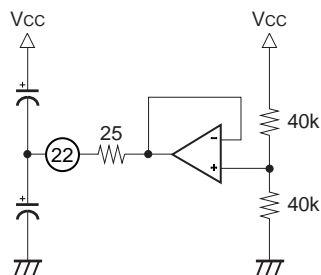


TE = Gain (F – E)

Low-frequency gain	ROM: 20dB
	RW: 32dB
$f_c$ (typ.)	ROM: 1MHz
	RW: 250kHz

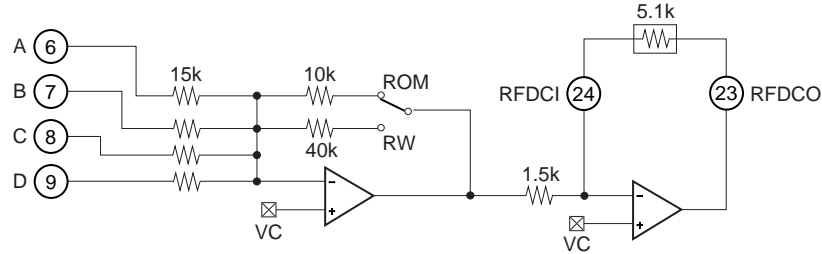
• VC Buffer

This outputs the VC ((1/2) Vcc) voltage. The maximum output current is approximately ±3mA.



• RFDC

The signals input via the A, B, C and D pins are added, amplified and the RFDC signal is output. RW/ROM switching, low-frequency gain adjustment and offset adjustment are possible.

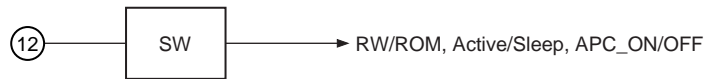


RFDC = Gain (A + B + C + D)  
 Low-frequency gain ROM: 20dB  
                           RW: 32dB  
 fc (Typ.) ROM: 12MHz  
                           RW: 5MHz

The gain can be adjusted by the external resistance connected between Pins 23 and 24.

• SW

This controls the laser (APC) on/off, active/sleep mode, and RW/ROM mode switching. Switching is controlled by the voltage applied to the SW pin (Pin 12).



The VC buffer is kept active even in sleep mode. In the function block, BGR and MODE\_SW are always set to active mode.

Item	APC	Active/Sleep	RW/ROM
Control voltage			
Vcc	ON	Active	RW
VC or Hi-Z	OFF	Sleep	—
GND	ON	Active	ROM

## Notes on Operation

### Stabilizing the RFAC signal

The RFAC system (RFSUM + EQ) is comprised entirely of non-inverted function blocks.

This is in order to support pickups with built-in RFSUM.

Therefore, if the voltage gain of each block is increased, a feedback loop is formed over the entire RFAC system causing the RFAC signal to become unstable (oscillate).

In these cases, it is recommended to lower the EQ frequency response and the boost gain. This has a large effect on the board (power supply, I/O signal cross talk, etc.) loop. The RFAC signal easily becomes unstable if the VCA gain is increased, the EQ boost frequency is set to a high frequency, the EQ boost amount is increased, etc.

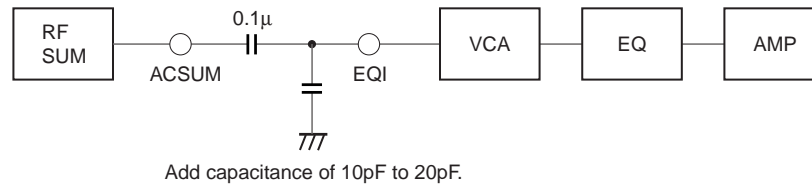
The VCA gain is low in ROM mode, so the RFAC signal is stable. Also, when not using RFSUM, the RFAC signal is stabilized because the overall gain is low.

The area where the RFAC signal becomes unstable is thought to vary for each set, as this is greatly affected by the board loop as noted above.

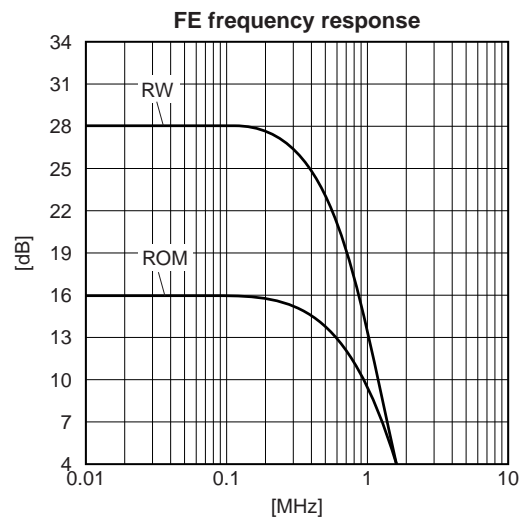
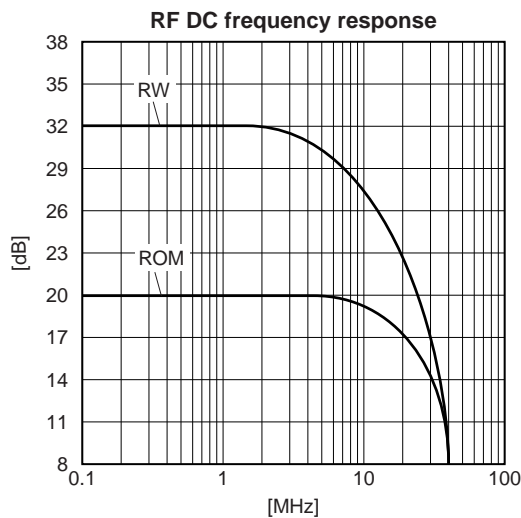
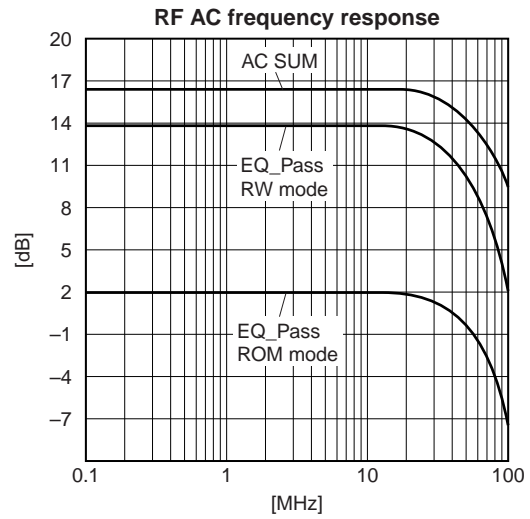
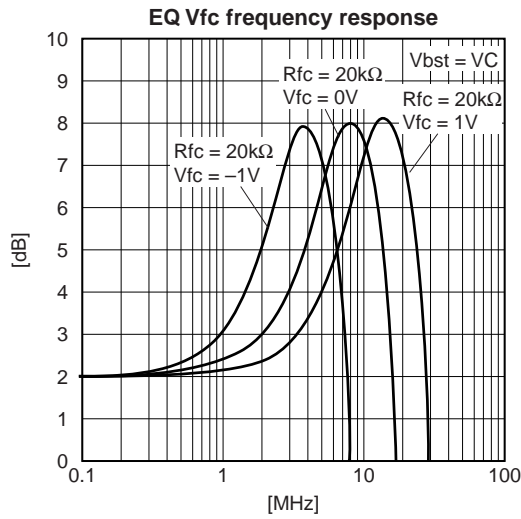
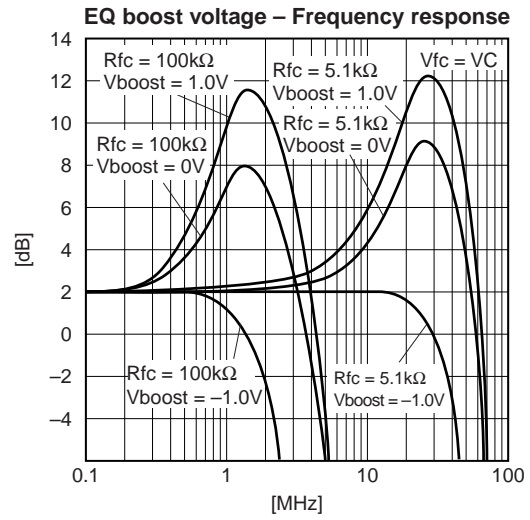
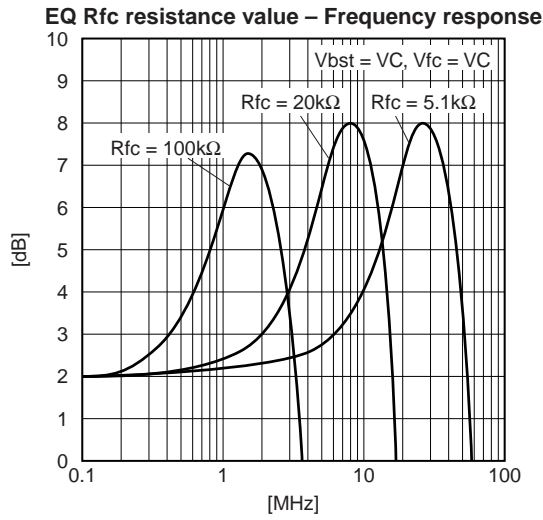
### Proposed stabilization measures

The board and other loop characteristics can be changed by adding external capacitance as noted below.

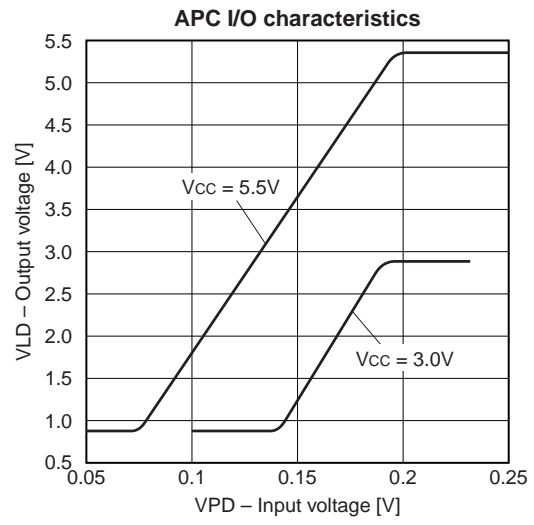
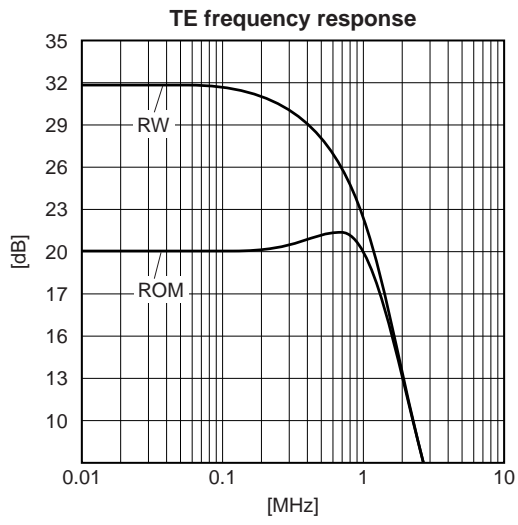
This has a particularly large effect on the stabilization when using RFSUM.



Example of Representative Characteristics

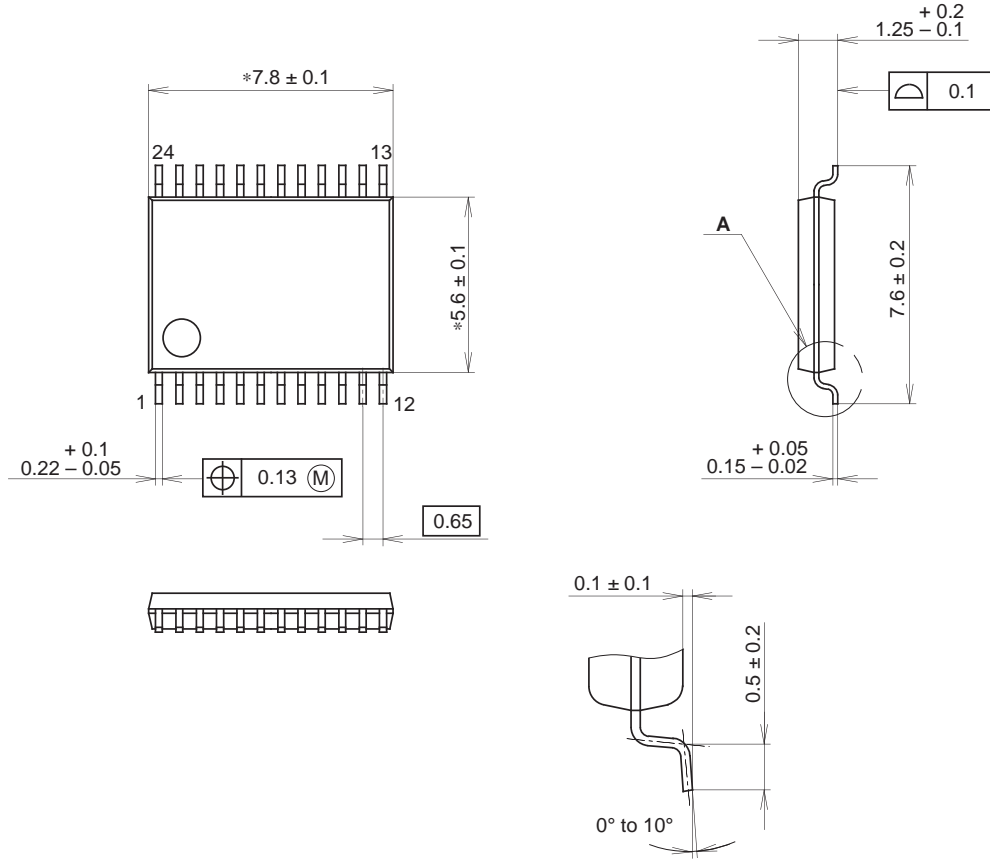






Package Outline Unit: mm

24PIN SSOP(PLASTIC)



NOTE: Dimensions "\*" does not include mold protrusion.

DETAIL A

PACKAGE STRUCTURE

SONY CODE	SSOP-24P-L01
EIAJ CODE	SSOP024-P-0056
JEDEC CODE	_____

PACKAGE MATERIAL	EPOXY RESIN
LEAD TREATMENT	SOLDER/PALLADIUM PLATING
LEAD MATERIAL	42/COPPER ALLOY
PACKAGE MASS	0.1g

NOTE : PALLADIUM PLATING

This product uses S-PdPPF (Sony Spec.-Palladium Pre-Plated Lead Frame).